

Data sheet Product ICK SMD M 17 MI



Heatsinks and active heatsinks for processors>Heatsinks for DIL-IC, PLCC and SMD

14 x 6 mm, for SMD components and others

Features

case type:	SMD
width:	14 mm
height:	6 mm
plate thickness:	1.8 mm
length:	17 mm
thermal resistance:	40 K/W
surface:	solderable surface

Technical Drawing

